

TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (U-MOSIII)

SSM6K25FE

High Speed Switching Applications

- Optimum for high-density mounting in small packages
- Low on-resistance: $R_{on} = 395m\Omega$ (max) (@ $V_{GS} = 1.8 V$)
 $R_{on} = 190m\Omega$ (max) (@ $V_{GS} = 2.5 V$)
 $R_{on} = 145m\Omega$ (max) (@ $V_{GS} = 4.0 V$)

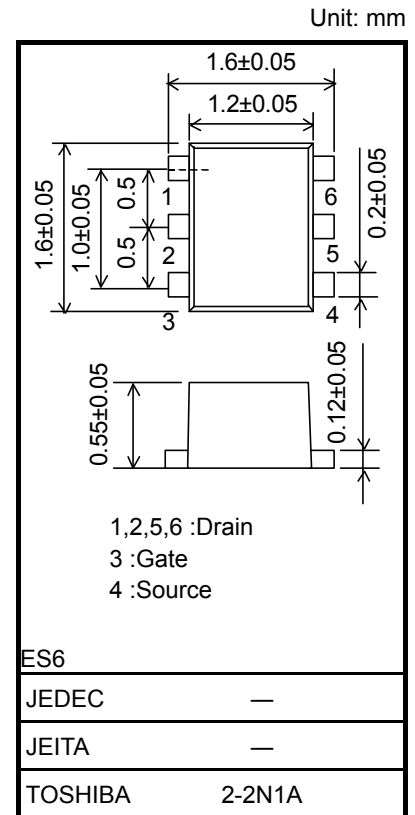
Absolute Maximum Ratings (Ta = 25°C)

| Characteristics | | Symbol | Rating | Unit |
|---------------------------|-------|-------------------|----------|------|
| Drain-Source voltage | | V_{DS} | 20 | V |
| Gate-Source voltage | | V_{GSS} | ± 12 | V |
| Drain current | DC | I_D | 0.5 | A |
| | Pulse | I_{DP} | 1.5 | |
| Drain power dissipation | | P_D (Note 1) | 500 | mW |
| Channel temperature | | T_{ch} | 150 | °C |
| Storage temperature range | | T_{stg} | -55~150 | °C |

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

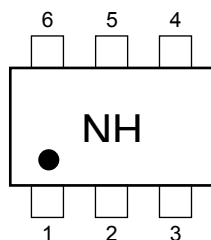
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Mounted on FR4 board.
 (25.4 mm × 25.4 mm × 1.6 t, Cu Pad: 645 mm²)

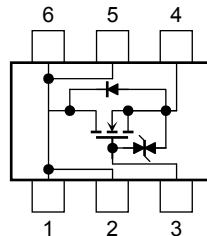


Weight: 3.0 mg (typ.)

Marking



Equivalent Circuit (top view)



Handling Precaution

When handling individual devices (which are not yet mounted on a circuit board), be sure that the environment is protected against electrostatic electricity. Operators should wear anti-static clothing, and containers and other objects that come into direct contact with devices should be made of anti-static materials.

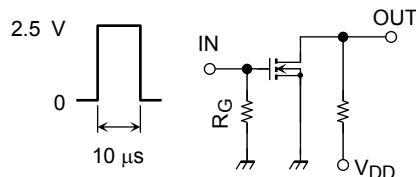
Electrical Characteristics (Ta = 25°C)

| Characteristics | Symbol | Test Condition | Min | Typ. | Max | Unit |
|--------------------------------|---------------|--|-----|------|---------|------------|
| Gate leakage current | I_{GSS} | $V_{GS} = \pm 12V, V_{DS} = 0$ | — | — | ± 1 | μA |
| Drain-Source breakdown voltage | $V_{(BR)DSS}$ | $I_D = 1 mA, V_{GS} = 0$ | 20 | — | — | V |
| | $V_{(BR)DSX}$ | $I_D = 1 mA, V_{GS} = -12 V$ | 10 | — | — | |
| Drain cut-off current | I_{DSS} | $V_{DS} = 20 V, V_{GS} = 0$ | — | — | 1 | μA |
| Gate threshold voltage | V_{th} | $V_{DS} = 3 V, I_D = 0.1 mA$ | 0.5 | — | 1.1 | V |
| Forward transfer admittance | $ Y_{fs} $ | $V_{DS} = 3 V, I_D = 0.25 A$ (Note2) | 1.2 | 2.4 | — | S |
| Drain-Source on-resistance | $R_{DS(ON)}$ | $I_D = 0.25 A, V_{GS} = 4.0 V$ (Note2) | — | 125 | 145 | m Ω |
| | | $I_D = 0.25 A, V_{GS} = 2.5 V$ (Note2) | — | 150 | 190 | |
| | | $I_D = 0.25 A, V_{GS} = 1.8 V$ (Note2) | — | 200 | 395 | |
| Input capacitance | C_{iss} | $V_{DS} = 10 V, V_{GS} = 0, f = 1 MHz$ | — | 268 | — | pF |
| Reverse transfer capacitance | C_{rss} | $V_{DS} = 10 V, V_{GS} = 0, f = 1 MHz$ | — | 34 | — | pF |
| Output capacitance | C_{oss} | $V_{DS} = 10 V, V_{GS} = 0, f = 1 MHz$ | — | 44 | — | pF |
| Switching time | Turn-on time | t_{on} | — | 11 | — | ns |
| | Turn-off time | t_{off} | | | | |

Note2: Pulse test

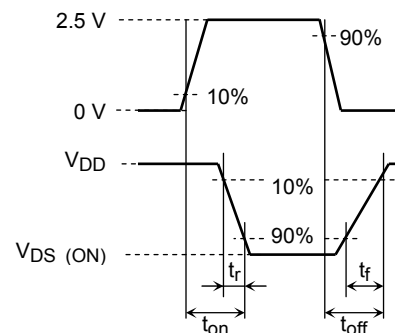
Switching Time Test Circuit

(a) Test Circuit

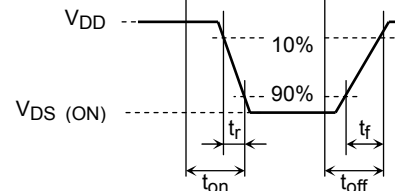


$V_{DD} = 10 V$
 $R_G = 4.7 \Omega$
 D.U. $\leq 1\%$
 V_{IN} : $t_r, t_f < 5 ns$
 Common Source
 $T_a = 25^\circ C$

(b) V_{IN}



(c) V_{OUT}

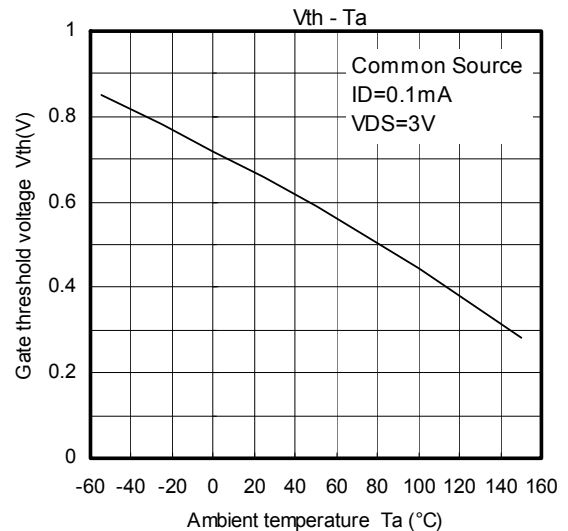
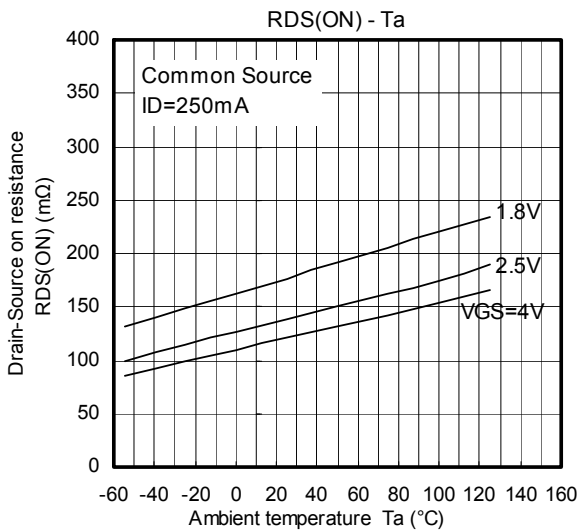
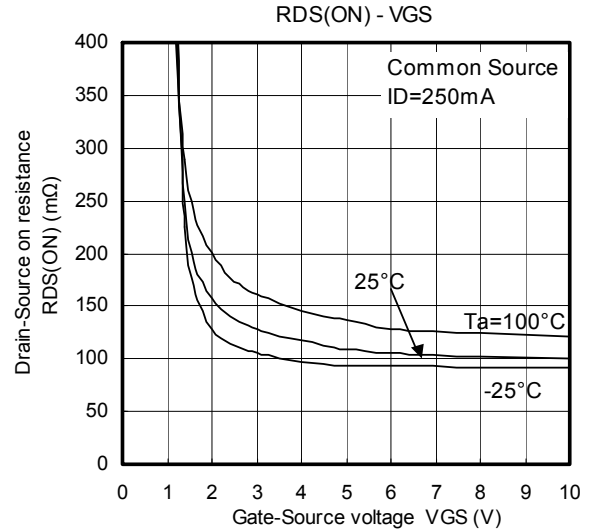
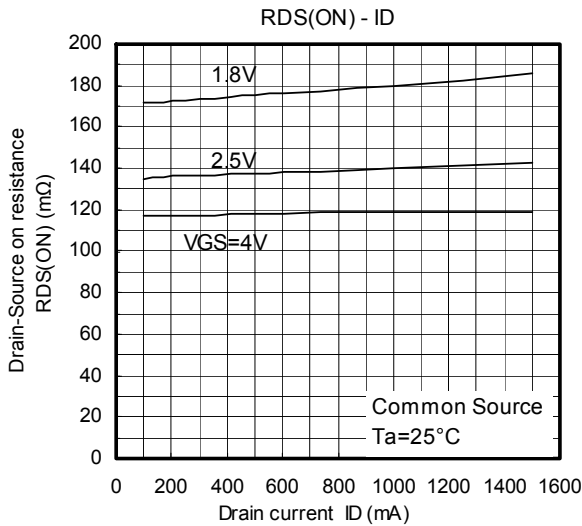
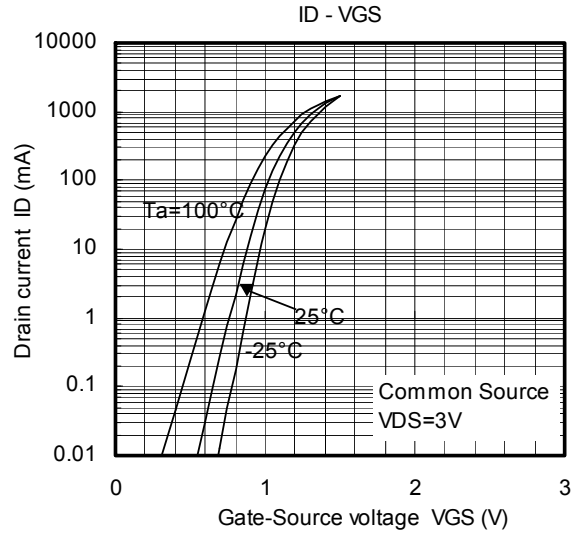
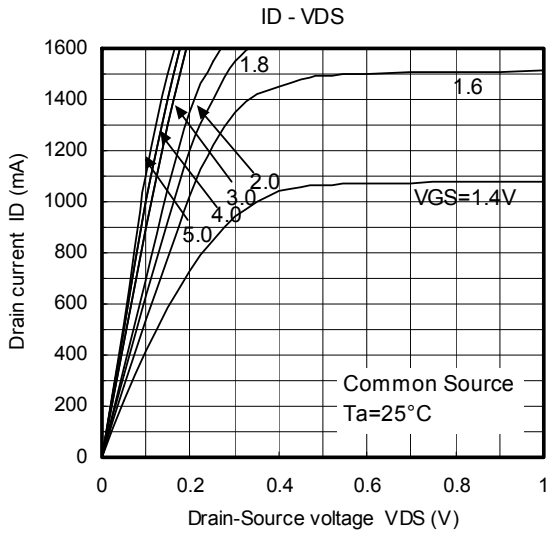


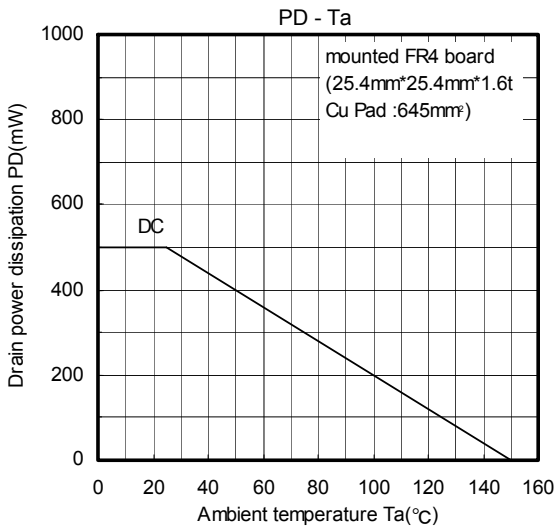
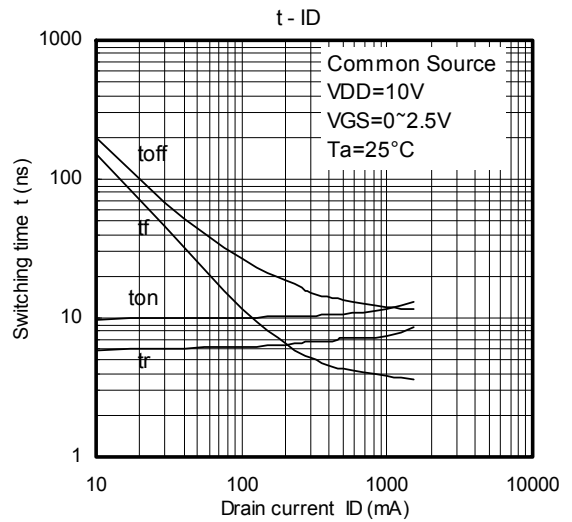
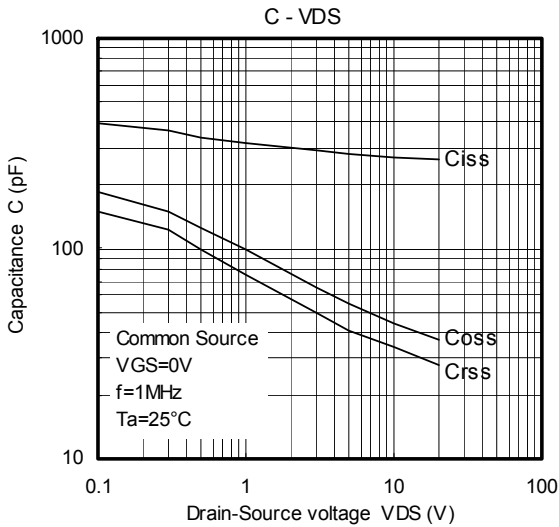
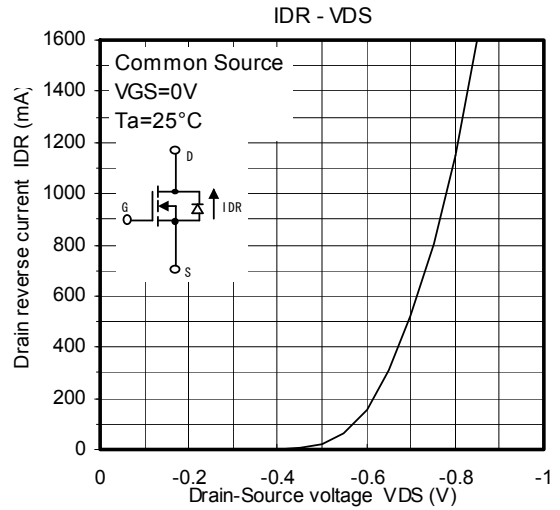
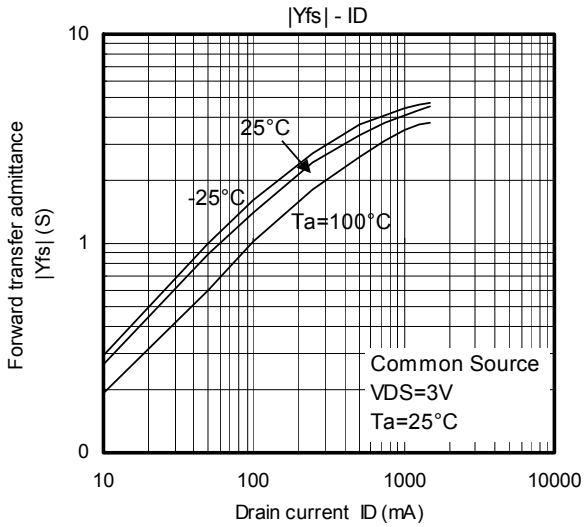
Precaution

V_{th} can be expressed as the voltage between gate and source when the low operating current value is $I_D = 100 \mu A$ for this product. For normal switching operation, $V_{GS(ON)}$ requires a higher voltage than V_{th} and $V_{GS(OFF)}$ requires a lower voltage than V_{th} .

(The relationship can be established as follows: $V_{GS(OFF)} < V_{th} < V_{GS(ON)}$)

Please take this into consideration when using the device.





RESTRICTIONS ON PRODUCT USE

20070701-EN GENERAL

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